

[illegible]

/ Descriptions

SOT-363 Y Z Z 2 [NPN \] ^ _ ` a M
Double

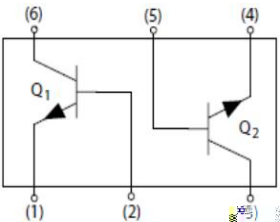
/ Features

b c d e f ,g h MMDT5401 i j M F G k l M

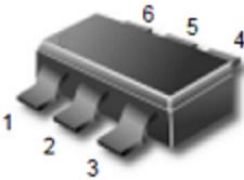
/ Applications

m n o p f e q r M

/ Equivalent Circuit



/ Pinning

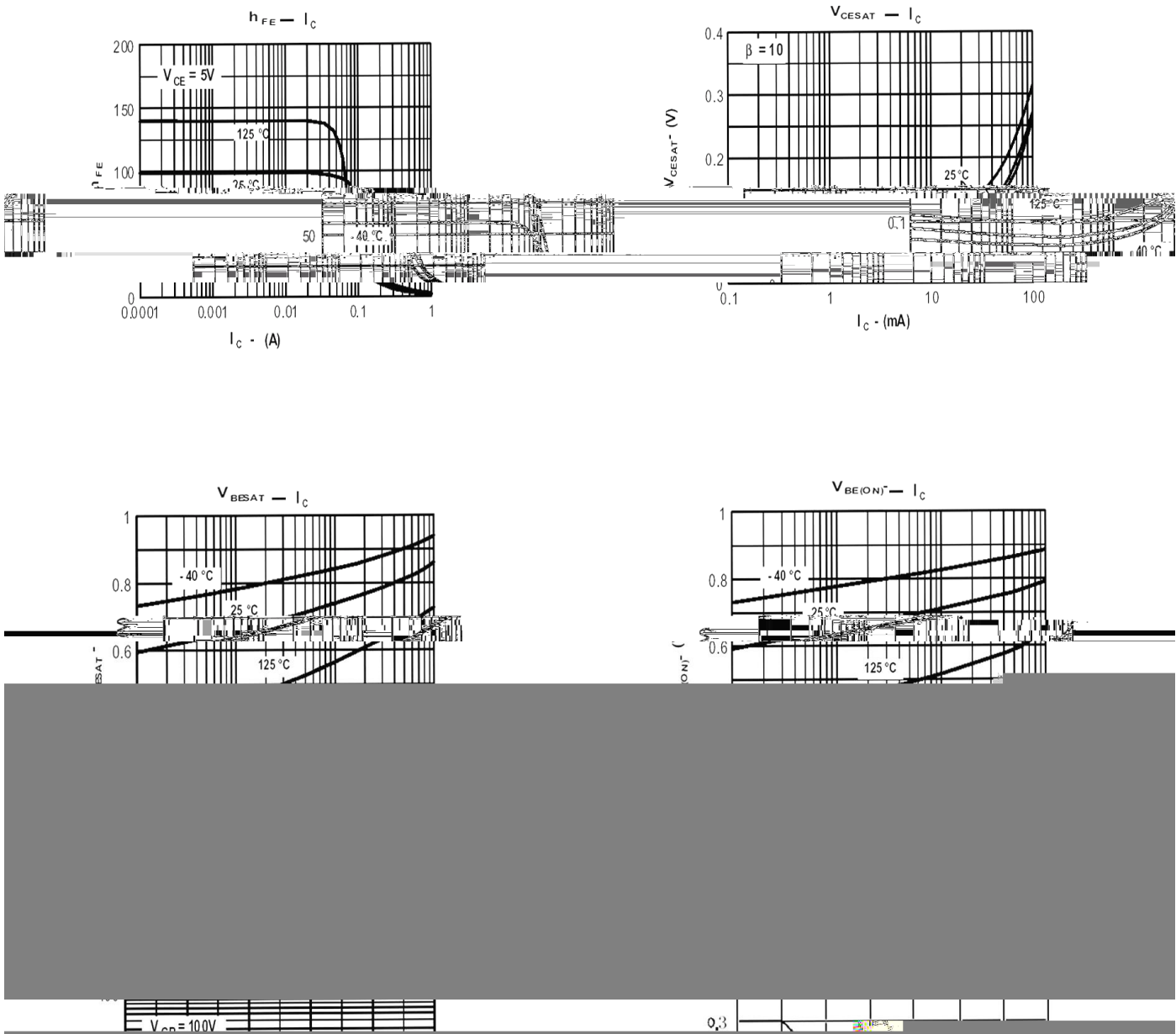


s t s t s t

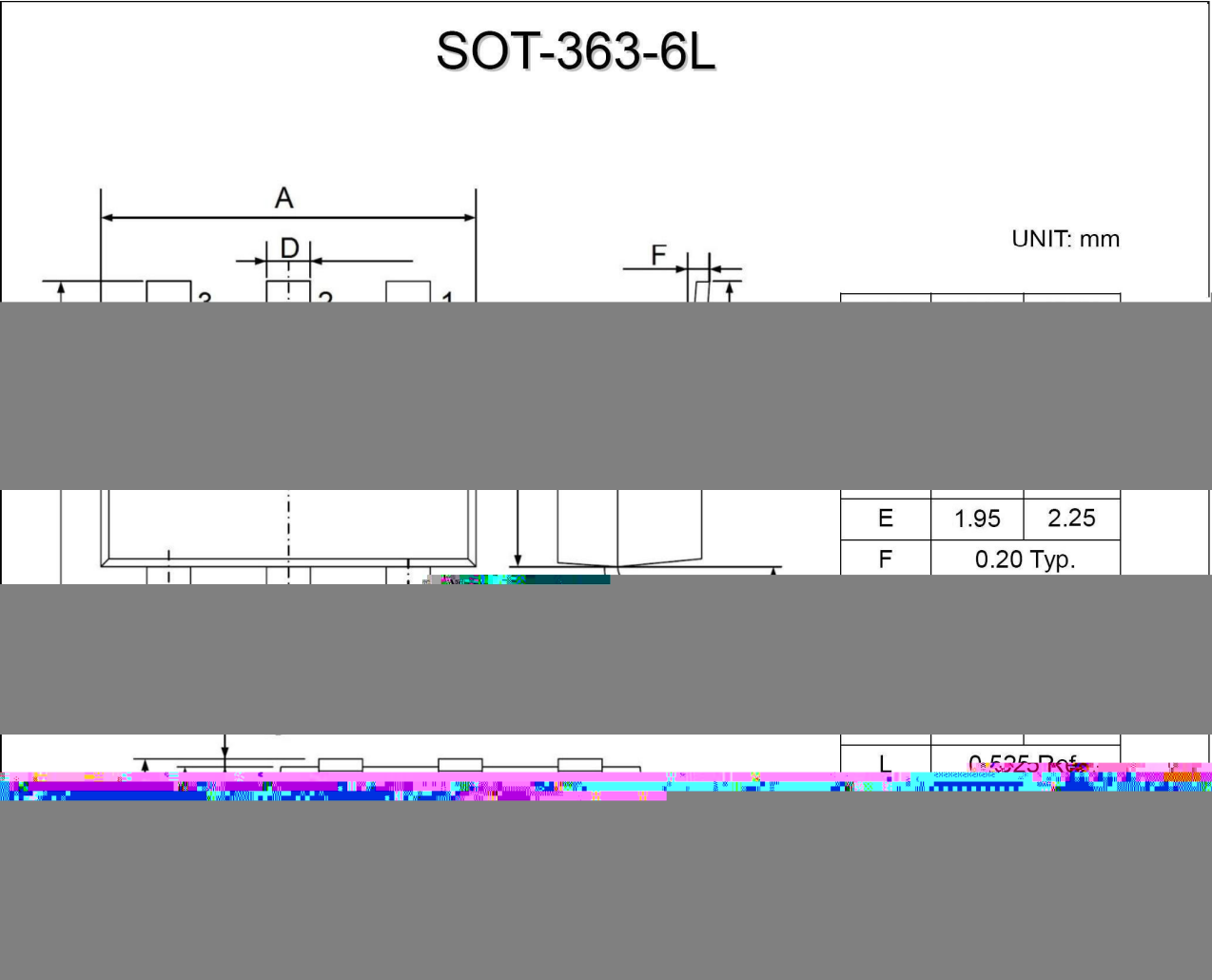
/ h_{FE} Classifications & Marking

u v	w x	v y	z {

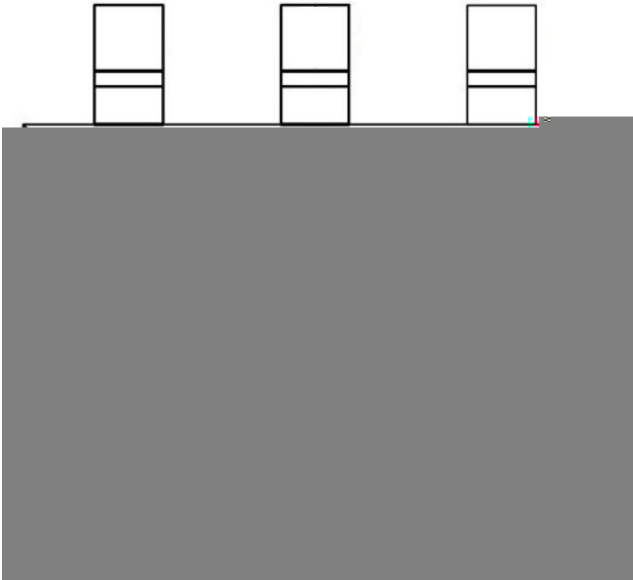
/ Electrical Characteristic Curve



/ Package Dimensions



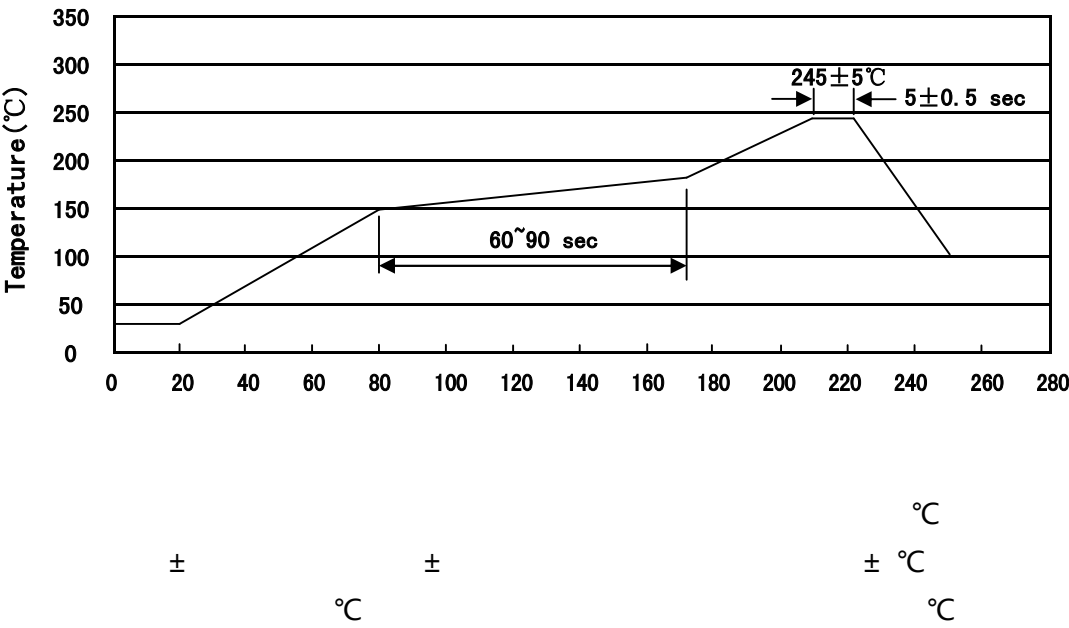
/ Marking Instructions



¥ | t
● t § " 1© a
G1 t § □ x « '
***: § ¬ k - x « ' H® ¬ k - x ¯ °

● t "1" Pin
G1 t
***:

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

± °C ± °C

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-363	3,000	10	30,000	6	180,000	7" ×8	180×120×180	390×385×205

/ Notices